# **BLF8G27LS-140**

# Power LDMOS transistor

**AMPLEON** 

Rev. 3 — 1 September 2015

Product data sheet

## 1. Product profile

### 1.1 General description

140 W LDMOS power transistor for base station applications at frequencies from 2500 MHz to 2700 MHz.

Table 1. Typical performance

Typical RF performance at  $T_{case} = 25$  °C in a common source class-AB production test circuit.

Test signal	f	I <sub>Dq</sub>	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	$\eta_{D}$	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	2600 to 2700	1300	32	45	17.4	32	-30 <sup>[1]</sup>
2-carrier W-CDMA	2600 to 2700	1300	28	35	17.0	29	-31 <u>[1]</u>

<sup>[1]</sup> Test signal: 3GPP test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low R<sub>th</sub> providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

■ RF power amplifier for W-CDMA base stations and multi carrier applications in the 2500 MHz to 2700 MHz frequency range

## 2. Pinning information

Table 2. Pinning

	3			
Pin	Description	Sim	plified outline	Graphic symbol
1	drain			,
2	gate		1	
3	source	[1]	2	2 -
				3 sym112
				sym112

<sup>[1]</sup> Connected to flange.

## 3. Ordering information

Table 3. Ordering information

Type number	Packag	ge		
	Name	Description	Version	
BLF8G27LS-140	-	earless flanged ceramic package; 2 leads	SOT502B	

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
V <sub>GS</sub>	gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		<u>[1]</u> _	225	°C

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability.

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_L$ = 55 W	0.27	K/W

### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.16 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 216 mA	1.5	1.9	2.3	V
I <sub>DSS</sub>	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	4.5	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$	-	40	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	450	nA
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; $I_{D}$ = 10.8 A	-	16	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 7.56 \text{ A}$	-	0.06	-	Ω

#### Table 7. RF characteristics

Test signal: 2-carrier W-CDMA; PAR 8.4 dB at 0.01 % probability on CCDF; 3GPP test model 1; 64 DPCH;  $f_1$  = 2622.5 MHz;  $f_2$  = 2627.5 MHz;  $f_3$  = 2682.5 MHz;  $f_4$  = 2687.5 MHz; RF performance at  $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 45 W$	15.8	17.4	-	dB
RLin	input return loss	$P_{L(AV)} = 45 W$	-	-18	-8	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 45 W$	27	32	-	%
ACPR <sub>5M</sub>	adjacent channel power ratio (5 MHz)	P <sub>L(AV)</sub> = 45 W	-	-30	-27	dBc

### 7. Test information

### 7.1 Ruggedness in class-AB operation

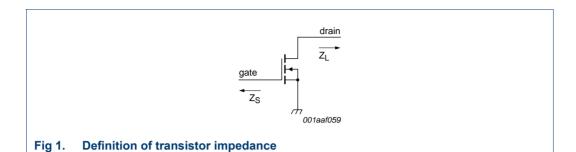
The BLF8G27LS-140 is capable to withstand a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $P_L$  = 180 W (CW); f = 2620 MHz.

## 7.2 Impedance information

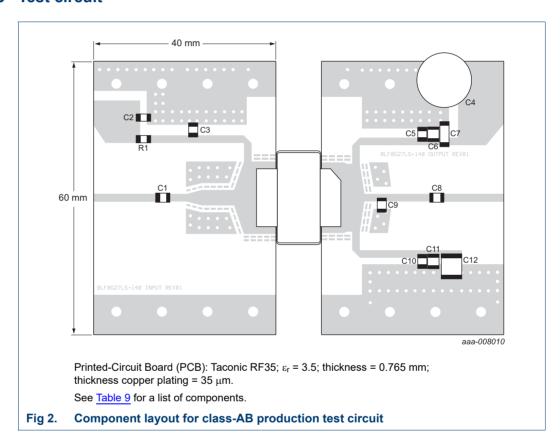
Table 8. Typical impedance  $I_{Dq} = 1300 \text{ mA}$ ;  $V_{DS} = 32 \text{ V}$ .

f	Z <sub>S</sub> [1]	Z <u>L<sup>[1]</sup></u>
(MHz)	(Ω)	(Ω)
2600	2.30 - j4.90	1.40 – j3.10
2700	3.80 – j4.50	1.40 – j3.10

[1]  $Z_S$  and  $Z_L$  defined in Figure 1.



### 7.3 Test circuit



BLF8G27LS-140#3

Table 9. List of components

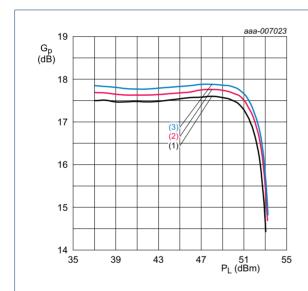
For test circuit see Figure 2.

Component	Description	Value		Remarks
C1, C3, C5, C8, C10	multilayer ceramic chip capacitor	10 pF	[1]	ATC100B
C2	multilayer ceramic chip capacitor	1 μF, 25 V	[2]	Murata
C4	electrolytic capacitor	470 μF, 63 V		
C6, C11	multilayer ceramic chip capacitor	1 μF, 50 V	[2]	Murata
C7, C12	multilayer ceramic chip capacitor	10 μF, 50 V	[2]	Murata
C9	multilayer ceramic chip capacitor	0.5 pF	[1]	ATC100B
R1	chip resistor	$3.9~\Omega$ , 1% tolerance		Philips SMD 1206

- [1] American Technical Ceramics type 100B or capacitor of same quality.
- [2] Murata or capacitor of same quality.

## 7.4 Graphical data

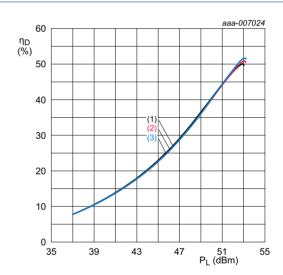
### 7.4.1 Pulsed CW



 $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA; f = 860 MHz;  $t_p$  = 100  $\mu s$ ;

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Power gain as a function of output power; Fig 3. typical values

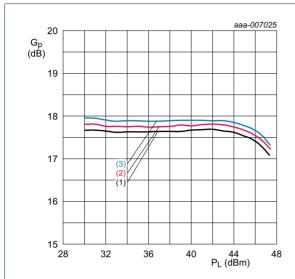


 $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA; f = 860 MHz;  $t_p$  = 100  $\mu s$ ;

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 4. Drain efficiency as a function of output power; typical values

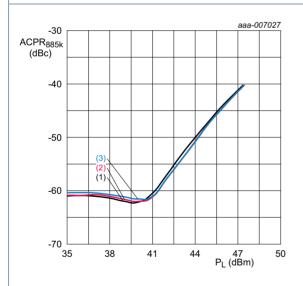
#### 7.4.2 IS-95



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

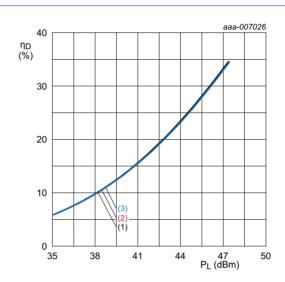
Fig 5. Power gain as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

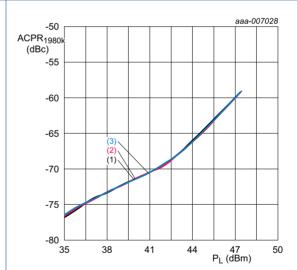
Fig 7. Adjacent channel power ratio (885 kHz) as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

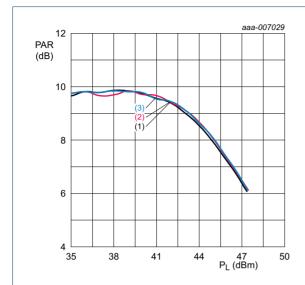
- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 6. Drain efficiency as a function of output power; typical values



- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

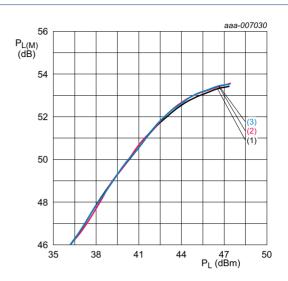
Fig 8. Adjacent channel power ratio (1980 kHz) as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 9. Peak-to-average power ratio as a function of output power; typical values

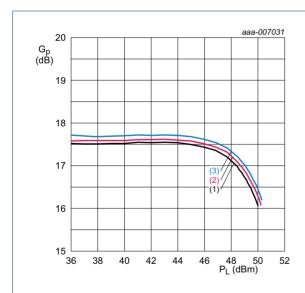


 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 10. Peak output power as a function of output power; typical values

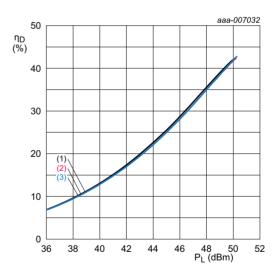
#### 7.4.3 1-Carrier W-CDMA



 $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA.

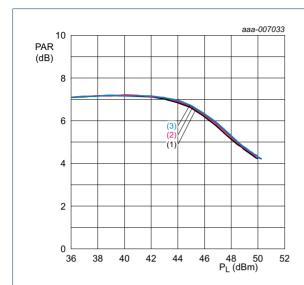
- (1) f = 2622.5 MHz
- (2) f = 2655 MHz
- (3) f = 2687.5 MHz

Fig 11. Power gain as a function of output power; typical values



- (1) f = 2622.5 MHz
- (2) f = 2655 MHz
- (3) f = 2687.5 MHz

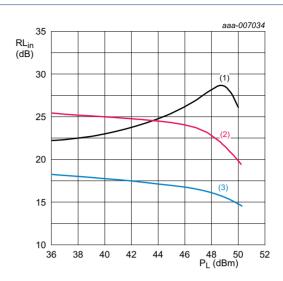
Fig 12. Drain efficiency as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2622.5 MHz
- (2) f = 2655 MHz
- (3) f = 2687.5 MHz

Fig 13. Peak-to-average power ratio as a function of output power; typical values

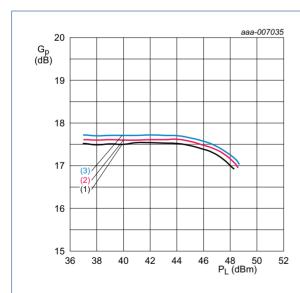


 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2622.5 MHz
- (2) f = 2655 MHz
- (3) f = 2687.5 MHz

Fig 14. Input return loss as a function of output power; typical values

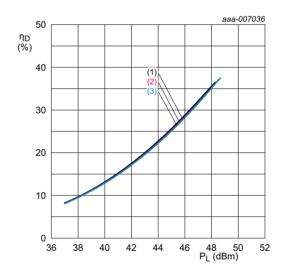
#### 7.4.4 2-Carrier W-CDMA



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

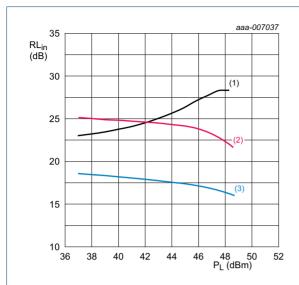
- (1) f = 2625 MHz
- (2) f = 2655 MHz
- (3) f = 2685 MHz

Fig 15. Power gain as a function of output power; typical values



- (1) f = 2625 MHz
- (2) f = 2655 MHz
- (3) f = 2685 MHz

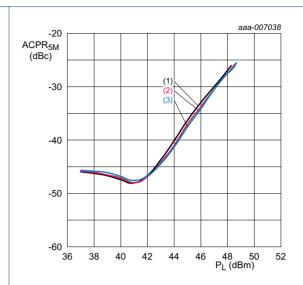
Fig 16. Drain efficiency as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2625 MHz
- (2) f = 2655 MHz
- (3) f = 2685 MHz

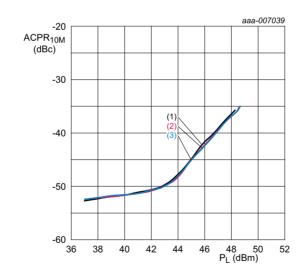
Fig 17. Input return loss as a function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2625 MHz
- (2) f = 2655 MHz
- (3) f = 2685 MHz

Fig 18. Adjacent channel power ratio (5 MHz) as a function of output power; typical values



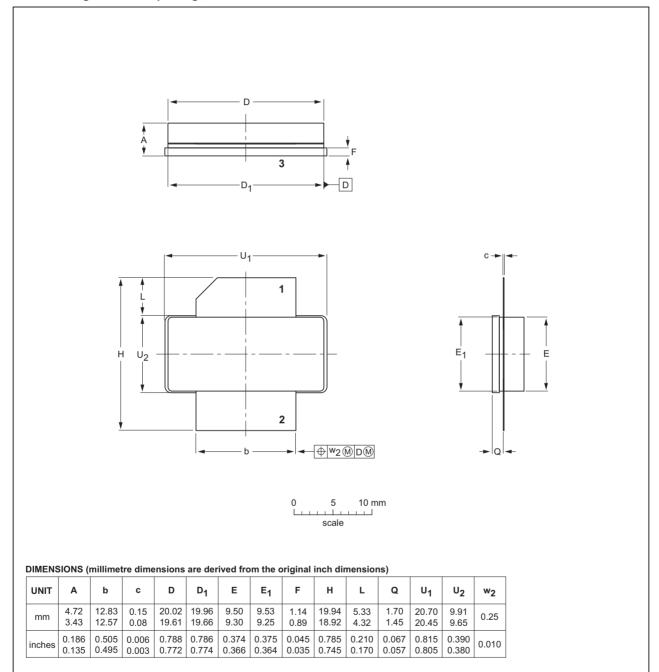
- (1) f = 2625 MHz
- (2) f = 2655 MHz
- (3) f = 2685 MHz

Fig 19. Adjacent channel power ratio (10 MHz) as a function of output power; typical values

## 8. Package outline

#### Earless flanged ceramic package; 2 leads

SOT502B



OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	155UE DATE	
SOT502B					<del>-07-05-09</del> 12-05-02	

Fig 20. Package outline SOT502B

## 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

## 10. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
IS-95	Interim Standard 95
LDMOS	Laterally Diffused Metal Oxide Semiconductor
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

## 11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BLF8G27LS-140#3	20150901	Product data sheet	-	BLF8G27LS-140 v.2			
Modifications:		<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> </ul>					
	<ul> <li>Legal texts h</li> </ul>	Legal texts have been adapted to the new company name where appropriate.					
BLF8G27LS-140 v.2	20130605	20130605 Product data sheet - BLF8G27LS-140 v.					
BLF8G27LS-140 v.1	20130328	Objective data sheet	-	-			

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#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# **BLF8G27LS-140**

#### **Power LDMOS transistor**

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